Abstract—The realization of matched impedance wide-band amplifiers fabricated by InGaP–GaAs heterojunction bipolar transistor (HBT) process is reported. The technique of multiple feedback loops was used to achieve terminal impedance matching and wide bandwidth simultaneously. The experimental results showed that a small signal gain of 16 dB and a 3-dB bandwidth of 11.6 GHz with in-band input/output return loss less than −10 dB were obtained. These values agreed well with those predicted from the analytic expressions that we derived for voltage gain, transimpedance gain, bandwidth, and input and output impedances. A general method for the determination of frequency responses of input/output return losses (or $S_{11}$, $S_{22}$) from the poles of voltage gain was proposed. The intrinsic overdamped characteristic of this amplifier was proved and emitter capacitive peaking was used to remedy this problem. The tradeoff between the input impedance matching and bandwidth was also found.

Index Terms—InGaP–GaAs, multiple feedback, trans-impedance amplifier, wideband.

I. INTRODUCTION

WIDE-BAND amplifiers are used in variety of modern electronic systems such as microwave/lightwave communication and instrumentation [1]. Among the many versions of wide-band amplifiers, the so-called Kukielka configuration [2] is one of the popular circuits. It has been fabricated by silicon bipolar, AlGaAs–GaAs heterojunction bipolar transistor (HBT), and InAlAs–InGaAs HBT processes with excellent performance [3]–[5]. Recently, InGaP–GaAs HBT technology has attracted much attention because of its uniformity [6]–[9] and reliability [10]. However, no detailed account of the performance of the InGaP HBT wide-band amplifiers with Kukielka configuration has been reported in the literature. The design equations based directly on the Kukielka configuration have also not been given before.

Therefore, in this paper, we present the first demonstration of Kukielka wide-band amplifiers using InGaP–GaAs HBT process. Multiple feedback loops were used to achieve terminal impedance matching and wide bandwidth simultaneously. The capacitive peaking technique [11] was used to overcome the intrinsic overdamped frequency response of the Kukielka amplifiers and thus enhance the bandwidth. The experimental results showed that a small signal gain of 16 dB and a 3-dB bandwidth of 11.6 GHz with in-band input/output return loss less than −10 dB were achieved. These values were in good agreement with the values predicted by the analytic expressions that we derived for voltage gain, bandwidth, and input and output impedances. A method to calculate the frequency responses of input/output return losses based on the poles of voltage gain is also presented.

II. PRINCIPLES OF CIRCUIT DESIGN

The circuit topology of the Kukielka wide-band amplifier is shown in Fig. 1(a). The input stage consists of a single transistor $Q_1$ driving the output stage consisting of a transistor $Q_2$ with local shunt ($R_{12}$) and series ($R_{22}$) feedback. There is also an overall shunt-series feedback loop composed of resistors $R_{e2}$ and $R_{f1}$. Local shunt feedback around $Q_2$ gives a low impedance at the collector node of $Q_2$ for the output terminal impedance matching. Then, global shunt feedback is applied around this voltage amplifier via $R_{f2}$ to achieve the input matching condition. Clearly, this amplifier can be approximated by a two-pole system with the closed-loop poles determined by the following characteristic equation:

$$s^2 + s(\omega_{p1} + \omega_{p2}) + (1 + A_0/\beta)\omega_{p1}\omega_{p2} = 0 \quad (1)$$

where $A_0$ is open-loop gain at low frequencies, $\beta$ is the feedback factor, and $\omega_{p1}$ and $\omega_{p2}$ are the two poles of the A circuit. Thus, the closed-loop poles $P_1$ and $P_2$ are given by

$$P_1, P_2 = -\frac{1}{2}(\omega_{p1} + \omega_{p2}) \pm \frac{1}{2}\sqrt{(\omega_{p1} + \omega_{p2})^2 - 4(1 + A_0/\beta)\omega_{p1}\omega_{p2}}. \quad (2)$$

From this equation, we see that as the loop gain $T = A_0\beta$ is increased from zero, the poles are brought closer together. Then a value of loop gain is reached at which the poles become coincident. If the loop gain is further increased, the poles become...
Fig. 1. The ac schematics of the Kukielka amplifier. (a) Basic topology. (b) The A circuit of (a) for calculating voltage gain. (c) The A circuit of (a) for calculating current gain.

complex conjugate. The characteristic (1) can also be written in the standard form

\[ s^2 + \frac{\omega_0}{Q} s + \omega_0^2 = 0 \]  \hspace{1cm} (3)

where \( \omega_0 = \left(1 + A_{0}/\beta\right)(\omega_{p1}^2 + \omega_{p2}^2)^{1/2}/(\omega_{p1}^2 + \omega_{p2}^2) \). A value of \( Q = 0.707 \) results in the maximally flat response with a bandwidth of \( \omega_0 \). If \( \omega_{p1} \) is initially equal to \( \omega_{p2} \), then a loop gain of \( A_{0}/\beta = 1 \) is required to achieve the maximally flat response.

From the above description, we may summarize the design procedure of the Kukielka amplifier as follows. First, decide the required voltage gain. Then, bring the two poles to be equal by \( R_{e1} \) and \( R_{f2} \). Finally, adjust \( R_{e2} \) and \( R_{f1} \) for the output impedance and input impedance matching, respectively. In order to go through the above-mentioned design procedure, the formulas for poles, voltage gain, current gain, loop gain, and input and output resistances have to be found. These derivations are given in the following.

### A. Positions of Poles

Careful analysis of the circuit (in the absence of global feedback) [2], [13] yields approximate pole positions given by

\[
\omega_{p1} \approx -\frac{C_{\pi 1} \times g_{m1}}{1 + g_{m1} \times R_{e1}} \times [(R_u + r_{b1} + R_{e1}) \times (R_{f1} + R_{e2})] \\
\approx \frac{\omega_{1}^2}{g_{m1} \times R_{e1}} (4a)
\]

\[
\omega_{p2} \approx -\frac{g_{m2} \times C_{\pi 2}}{1 + g_{m2} \times R_{e2}} \times \frac{1 + G_{m2} \times (R_{cc} \div R_{L}) + r_{b2} + R_{e2}}{R_{f2} \div (R_{cc} \div R_{L})} \\
\approx \frac{\omega_{2}^2}{R_{f2}} (4b)
\]

where \( C_{\pi 1} \) and \( C_{\pi 2} \) are base–emitter junction capacitances of \( Q_1 \) and \( Q_2 \), \( r_{b1} \) and \( r_{b2} \) are the spreading base resistances of \( Q_1 \) and \( Q_2 \), \( g_{m1} \) and \( g_{m2} \) are the transconductances of \( Q_1 \) and \( Q_2 \); \( G_{m1} = g_{m1}/(1 + g_{m1} \times R_{e1}) \) and \( G_{m2} = g_{m2}/(1 + g_{m2} \times R_{e2}) \) are the effective transconductances of \( Q_1 \) and \( Q_2 \), and \( \omega_{p1} \) and \( \omega_{p2} \) are the cutoff frequencies of \( Q_1 \) and \( Q_2 \), respectively. Clearly, the two poles can be brought to be coincident by choosing suitable \( G_{m1} \) (i.e., \( R_{e1} \)) and \( R_{f2} \).

### B. Current and Voltage Gains

In order to calculate the current gain and voltage gain, two representations of the A circuit for the Kukielka amplifier without the global shunt-series feedback is shown in Fig. 1(b) and (c). In Fig. 1(b), the impedance at point \( K_1 \) looking into the base of \( Q_2 \) is given by

\[
R_{K1} = \frac{R_{f2} + R_{cc} \div R_{L}}{1 + G_{m2} \times (R_{cc} \div R_{L})} \\
\approx G_{m1} R_{K1} \frac{1}{1 - \frac{R_{K1}}{R_{f2}}} (5a)
\]

Therefore, the voltage gain of \( V_{out}/V_{in} \) without global feedback is

\[
A_V = \frac{V_{out}}{V_{in}} \approx G_{m1} R_{K1} G_{m2} \left(1 - \frac{R_{K1} \times R_{f2}}{R_{f2}}\right) (5b)
\]

The voltage gain in Fig. 1(a) with global feedback by inspection is then

\[
A_{VSF} = \frac{V_{out}}{V_{in}} = \frac{R_{in}}{R_{in} + R_{S}} A_V \\
\approx \frac{1}{2} A_V \approx \frac{1}{2} G_{m1} R_{f2} (5c)
\]

where \( R_{in} \) is the input resistance of the Kukielka amplifier with global feedback [see Fig. 1(a)]. The formula of \( R_{in} \) will be discussed shortly. When the input terminal impedance is matched to \( R_{S} \), if \( R_{f2} \) is much larger than \( R_{K1} \), then

\[
A_{VSF} \approx \frac{1}{2} A_V \approx \frac{1}{2} G_{m1} R_{f2} \\
(5d)
\]

The current gain \( I_{out}/I_{in} \) of the A circuit shown in Fig. 1(c) can be easily determined to be

\[
A_f = (R_{f1} + R_{e2}) \times G_{m1} \times \frac{R_{f2} + R_{cc} \div R_{L}}{1 + G_{m2} \times (R_{cc} \div R_{L})} (6a)
\]
Note that the feedback factor \( \beta_1 = R_{e2}/(R_{f1} + R_{e2}) \) and hence \( R_m = (R_{f1} + R_{e2})/(1 + A_{f1}/\beta_1) \) can be obtained easily according to the traditional shunt-series feedback theory.

Finally, the current gain \( I_{out}/I_S \) of the A circuit shown in Fig. 1(c) is given by

\[
A_{IS} = \frac{I_{out}}{I_S} = \frac{I_{out}}{I_{in}} \frac{R_S}{1 + \frac{R_S}{R_{f1} + R_{e2}}}. \tag{6b}
\]

As mentioned before, the input resistance is \( R_{in} = (R_{f1} + R_{e2})/(1 + A_{f1}/\beta_1) \) and hence the loop gain \( T \) of this shunt-series feedback amplifier can be represented as

\[
T = A_{IS} \times \beta_1 = \frac{A_{f1} \times \beta_1}{1 + (1 + A_{f1}/\beta_1) \frac{R_{in}}{R_S}}. \tag{7a}
\]

For matching \( R_{in} = R_s \), the loop gain \( T \) becomes

\[
T = A_{IS} \times \beta_1 = \frac{A_{f1} \times \beta_1}{1 + (1 + A_{f1}/\beta_1),} \tag{7b}
\]

Clearly, from the above expression, the loop gain \( T \) of the Kukielka amplifier is smaller than unity if input is matched. It is the intrinsic characteristic of this amplifier. This small loop gain explains why this configuration tends to give an overdamped response [2]. Since \( T < 1 \)

\[
Q = \frac{\sqrt{(1 + T)} \omega p1 + \omega p2}{\omega p1 + \omega p2} < \frac{\sqrt{2}}{\omega p1 + \omega p2} \leq \frac{1}{\sqrt{2}}.
\]

The last equality holds only if \( \omega p1 = \omega p2 \). Thus, because of the low loop gain, it is necessary to design the two open-loop pole positions to be nearly equal and the loop gain as close to 1 as possible, so that the maximally flat condition \( (Q = 1/\sqrt{2} = 0.707) \) can be approached. Capacitors can be added in parallel to \( R_{e1} \) and \( R_{e2} \) to introduce peaking, which compensates for the overdamped characteristic of this configuration.

The dc transimpedance gain \( AZ_{21} \) by definition is the output voltage (with open load \( R_{L} = \infty \)) divided by an ideal current source with \( R_S = \infty \), and hence can be easily shown to be

\[
AZ_{21} = \frac{A_{f1}}{1 + A_{f1}/\beta_1} \times (R_{f2}/R_{CC}). \tag{7c}
\]

### C. Input and Output Resistances

By inspection of Fig. 1(c), the input resistance \( R_{inA} \) of the A circuit is \( R_{f1} + R_{e2} \). From the results of the shunt-series feedback theory, the input resistance with feedback is given by

\[
R_{in} = \frac{R_{f1} + R_{e2}}{1 + A_{f1}/\beta_1} = \frac{R_{f1} + R_{e2}}{1 + \frac{R_{f1} + R_{e2}}{R_{f1} + R_{e2}} \frac{R_{m1}}{1 + G_{m2}(R_{CC}/R_L)G_{m2}R_{e2}}}. \tag{8a}
\]

If \( G_{m2}(R_{CC}/R_L) \gg 1, R_{f2} \gg R_{CC}/R_L \) and \( R_{CC} \gg R_L \), \( R_{in} \) can be reduced to

\[
R_{in} \approx \frac{R_{f1} + R_{e2}}{1 + G_{m1}R_{f2}/R_L} = \frac{R_{f1} + R_{e2}}{1 + A_{f1}/\beta_1}. \tag{8b}
\]

where \( \beta_1 \) is defined as \( R_{e2}/R_{f1} \). According to Fig. 1(a), \( \beta_1 \) has the physical meaning that a portion \( R_{e2}/R_{f1}(\beta_1) \) of the output voltage is fed back to the input through resistors \( R_{f1} \), assuming the current flowing through the feedback resistor \( R_{f1} \) is negligible. It is interesting to note that \( A_{f1}/\beta_1 \) is approximately equal to \( A_{f1}/\beta_1 \). As we well see, this equality is especially useful when one is designing a voltage amplifier rather than a current amplifier.

As for output resistance, unfortunately, the traditional shunt-series feedback theory cannot give the output resistance at collector node that we want. It only provides the output resistance seen between the emitter of \( Q_2 \) and resistance \( R_{e2} \) [12]. Therefore, we have to derive the output resistance directly from the Kukielka amplifier itself. The circuit diagram for the calculation of output resistance is shown in Fig. 2. When a test voltage \( V_z \) is applied to the collector node of \( Q_2 \), a voltage of \( V_{A1} = G_{m2}V_{O2}R_{e2} \) at \( A_1 \) is across the resistor \( R_{e2} \), assuming that the current flowing through the feedback resistor \( R_{f1} \) is small. Hence, a voltage of \( V_{A2} = G_{m2}V_{O2}R_{e2}R_{S}/(R_S + R_{f1}) \) appears at \( A_2 \) and a current \( I_{K2} \) of \( G_{m1}G_{m2}V_{O2}R_{e2}R_S/(R_S + R_{f1}) \) is induced at the collector of \( Q_1 \). As a result, the resistance looking into the collector of \( Q_1 \), represented by \( R_{K2} \), can be obtained:

\[
R_{K2} = \frac{V_{O2}}{I_{K2}} = \frac{R_S + R_{f1}}{R_SG_{m1}G_{m2}R_{e2}}. \tag{9a}
\]
The circuit in Fig. 2(a) then can be simplified to the one shown in Fig. 2(b). From this circuit, the impedance $R_{\text{out}}^2$ can be easily shown to be $R_{\text{out}}^2 = (R_{f2} + R_{\text{r2}})/(1 + G_{m2}R_{K2})$, and therefore the output resistance is given by

$$ R_{\text{out}} = R_{\text{out}}^2//R_C = \frac{R_{f2} + R_{\text{r2}}}{1 + G_{m2}R_{K2}}//R_C. \quad (9b) $$

Under the assumption that $R_C$ is very large, $R_{f1} \gg R_{\text{r2}}$, $A_V/\beta_r = G_{m2}R_{f2}R_{\text{r2}}/R_{f1}$, and (9b) equals $R_S$, the output impedance can be rewritten as

$$ R_{\text{out}} = \frac{A_V/\beta_r R_L + \left(\frac{1}{G_{m2}}\right)(2 + A_V/\beta_r)}{R_{f2} + 2 + A_V/\beta_r}. \quad (9c) $$

### D. Frequency Responses of $S_{21}$, $S_{11}$, $S_{22}$, $S_{12}$, $Z_{21}$, $Z_T$

Once the two poles and dc or midband gain are known, the frequency response of $S_{21} = 2\times$ (voltage gain) can be determined easily. However, the traditional theory on frequency response does not provide a general way to determine the frequency responses of input and output return losses, i.e., $|S_{11}|$ and $|S_{22}|$. Here, the determination of the frequency responses of input and output return losses from the poles of voltage gain is proposed. $S_{11}$ is given by

$$ S_{11} = \frac{Z_{in} - R_S}{Z_{in} + R_S} \quad (10a) $$

where $Z_{in}$ is the input impedance of the amplifier. The poles of $S_{11}$ are the roots of $Z_{in} + R_S = 0$. It is known that the poles of all $S$ parameters are the same [13] and hence $Z_{in} + R_S = 0$ is equivalent to the characteristic (1) for the closed-loop poles of voltage gain. The zeros of $S_{11}$ are the roots of $Z_{in} - R_S = 0$. This zero equation can be viewed as the transformation of the pole equation $Z_{in} + R_S = 0$ with $R_S$ replaced by $-R_S$. That is to say, the zero equation of $S_{11}$ can be obtained easily by replacing $R_S$ in (1) with $-R_S$. In other words, the zeros of $S_{11}$, $\omega Z_1$ and $\omega Z_2$ can be obtained by replacing the $R_S$ in the expressions of the poles $P_1$ and $P_2$ (or $\omega P_1$ and $\omega P_2$) with $-R_S$. At dc frequency, $S_{11} = (R_{\text{r2}} - R_S)/(R_{\text{r2}} + R_S)$ and therefore $S_{11}$ can be written as follows for all frequencies:

$$ S_{11} = \frac{Z_{in} - R_S}{Z_{in} + R_S} = \frac{R_{\text{r2}} - R_S}{R_{\text{r2}} + R_S} \frac{\left(1 + \frac{s}{\omega Z_1}\right)}{\left(1 + \frac{s}{\omega Z_2}\right)}. \quad (10b) $$

By similar arguments, $S_{22}$ can be given by

$$ S_{22} = \frac{Z_{\text{out}} - R_L}{Z_{\text{out}} + R_L} = \frac{R_{\text{out}} - R_L}{R_{\text{out}} + R_L} \frac{\left(1 + \frac{s}{\omega Z_3}\right)}{\left(1 + \frac{s}{\omega Z_4}\right)}. \quad (10c) $$

$\omega Z_3$ and $\omega Z_4$ are the zeros of $S_{22}$ and are obtained by replacing $R_L$ in the expressions of the poles $P_1$ and $P_2$ (or $\omega P_1$ and $\omega P_2$) with $-R_L$.

$S_{12}$ is the reverse voltage gain, which can be found easily once $R_{\text{out}}^2$ is known:

$$ S_{12} = 2 \left[\frac{1}{1 + \frac{R_L}{R_{\text{r2}}}} \frac{R_S + R_{f2}}{G_{m2}R_{\text{r2}}R_S + R_{f2}R_{m1}} \cdot \left(1 + \frac{1 + \frac{s}{\omega_{\text{z1}}}}{\left(1 + \frac{s}{\omega_{\text{z2}}}\right)} \right) \right] \quad (10d) $$

where $\omega_{\text{z1}} = 1/(C_{\tau 1} R_{e1})$ is the zero caused by $C_{\tau 1}$ and $R_{e1}$. The transimpedance $Z_{21}$ with open load can be given by

$$ Z_{21} = \frac{A_{f1}}{1 + A_{f1} \cdot \beta_r} \times (R_{f2}/R_{\text{r2}}) \left(\frac{1}{1 + \frac{s}{P_1}}\right) \left(\frac{1 + \frac{s}{P_2}}{1 + \frac{s}{P_2}}\right) \quad (10e) $$

where $P_1'$ and $P_2'$ are the two poles given by (2) but with $R_L = R_S = \infty$.

Finally, the transimpedance $Z_T$ with 50-Ω load is calculated according to the following widely used formula:

$$ Z_T = \frac{S_{21}}{1 - S_{11}} \times 50. \quad (10f) $$

### E. Design Equations

Armed with the expressions for poles, voltage gain, current gain, and input and output resistances, we are now ready to derive some useful design equations. Under the assumptions that $G_{m3}R_L \gg 1$, $R_{e1} \ll R_S$, and $\omega_{\tau 1} = \omega_{\tau 2}$, the condition that $\omega_{P1} = \omega_{P2}$ reduces to

$$ R_{f2} = G_{m1}R_S + R_{e1}R_{\text{r2}}//R_L \approx G_{m1}R_S(R_{\text{r2}}//R_L). \quad (11a) $$

The combination of (11a) and (5d) yields the following first-order design equations:

$$ R_{f2} = \sqrt{2A_{f1}S_F R_S (R_L//R_{\text{r2}})} \quad (11b) $$

$$ R_{e1} = \frac{R_S \times (R_{\text{r2}}//R_L)}{R_{f2}} - \frac{1}{g_{m1}}. \quad (11c) $$

g_{m1} is dependent on $L_3$, which is decided by the consideration of power consumption and noise figure. Similar design equations (11a)–(11c) have also been derived previously by Hull and Meyer [2] from the configuration consisting of two local shunt–shunt feedback amplifiers. According to (8a) and (8b), $R_{f1}$ is given by

$$ R_{f1} \approx (1 + A_{f1} \beta_r)R_S = (1 + A_{V/\beta_r})R_S. \quad (11d) $$

The $\beta_r$ (or $R_{e2}$) remains to be determined in order to find the value of $R_{f1}$. Usually, a large $R_{f1}$ is desirable from the requirement of a low noise figure, which means that a large $A_{f1} \beta_r$ or $A_{V/\beta_r}$ is favorable. $R_{e2}$ can be decided by the output matching
condition. By setting $R_{\text{cut}}$ of (9c) equal to $R_L$, the following equation is obtained:

$$R_{\text{cut}} = \frac{A_V\beta_V R_L + \left(\frac{1}{g_{m2}}\right)(2 + A_V\beta_V)}{\frac{A_V\beta_V R_L}{R_2} + (2 + A_V\beta_V)} = R_L. \tag{12a}$$

From the above expression, the value of $R_{\text{cut}}$ in general, can be obtained easily.

$$R_{\text{cut}} = \frac{R_L \left(\frac{A_V\beta_V R_L}{R_2} + 2\right) + \frac{1}{g_{m2}}}{2 + A_V\beta_V}. \tag{12b}$$

$R_{\text{cut}}$ is determined by the dc bias point, which should be around $1/3$ of the supply voltage [12]. The bandwidth can be estimated to be $1.414 \omega_{\text{p}1}$ or $1.414 \omega_{\text{p}2}$, assuming maximum flat condition.

### III. Circuit Implementation and Measured Results

The schematic of the InGaP–GaAs HBT wide-band amplifier is shown in Fig. 3. Note that the second stage is replaced with the compound transistor, which has a resistive Darlington configuration consisting of $Q_{2a}$ and $Q_{2b}$. The primary motive for use of the compound transistor is to achieve a higher gain–bandwidth product. The effective transconductance of the compound transistor can be expressed as

$$g_{m\text{eff}} = g_{m2a} + g_{m2a}g_{m2b} \left(\frac{R}{\omega_{2b}}\right) \approx g_{m2b}. \tag{13}$$

where $g_{m2a}$ and $g_{m2b}$ are the transconductances of $Q_{2a}$ and $Q_{2b}$, respectively, $R$ is $R_1 + R_2$, and $\omega_{2b}$ is the base–emitter resistance of $Q_{2b}$. Clearly, the effective transconductance is dominated by the second transistor ($Q_{2b}$) of the Darlington configuration. It is also known that in ideal conditions, the Darlington configuration appears as a single transistor with twice $f_T$. Therefore, in designing the Kukielka circuit with the Darlington pair, the transconductance $g_{m2}$ and cut-off frequency $\omega_{2b}$ of the second stage discussed in the previous section may be replaced by $g_{m\text{eff}}$ and $2\omega_{2b}$. Going through the design procedure described in the previous section, and after some fine tunings, circuit parameters were obtained as indicated in Fig. 3.

Note that capacitors were added in parallel to $R_{e1}$ and $R_{e2}$ to introduce peaking for the compensation of the intrinsic over-damped characteristic of the Kukielka amplifier. The peaking capacitors will change the input and output impedance calculations given previously. Therefore, care must be taken with this technique because it will have a detrimental effect on the large signal response (often introducing ringing) and the small-signal group delay.

The wideband amplifier was fabricated with InGaP–GaAs HBT process provided by the commercial foundry of GCS. InGaP–GaAs HBT technology has been chosen because of its higher uniformity [6]–[9], higher reliability [10], and lower 1/f noise [14], as compared with the traditional Al-GaAs–GaAs HBT process. The device sizes of $Q_{1}$, $Q_{2a}$, and $Q_{2b}$ are $1.4 \mu m \times 9 \mu m$, $1.4 \mu m \times 6 \mu m$, and $1.4 \mu m \times 9 \mu m$, respectively, while the bias currents for the transistors are 4.8, 2.9, and 11.5 mA, respectively. These HBTs have the following device parameters.

- $f_T = 40 \text{ GHz}$, $C_{jc1} = 30 \text{ fF}$, $C_{jc2} = C_{bc1} = C_{bc2} = 0 \text{ fF}$,
- $\eta_{b1} = 28 \Omega$, $g_{m1} = 187 \text{ mS}$,
- $f_T = 35 \text{ GHz}$, $C_{jc1a} = 45 \text{ fF}$, $C_{jc2a} = C_{jc2b} = 0 \text{ fF}$,
- $\eta_{b2a} = 15 \Omega$, $g_{m2} = 109 \text{ mS}$,
- $f_T = 36 \text{ GHz}$, $C_{jc1b} = 45 \text{ fF}$, $C_{jc2b} = 0 \text{ fF}$,
- $\eta_{b2b} = 10 \Omega$, $g_{m2b} = 363 \text{ mS}$.

Computer simulations were done by HP Series IV high-frequency circuit design tools. Since this circuit is high frequency in nature, circuit simulations with and without the transmission-line model (TLM) were compared. In order to reduce the chip area and reflections of waves, meandering shapes of resistors were carefully laid out. Direct cascade probable coplanar wave-guide patterns were also laid out for ease of microwave testing. The die photograph of the finished circuit is shown in Fig. 4. Note that the circuit (excluding the patterns for testing) only occupies a very small area of $450 \mu m \times 500 \mu m$ because no inductor was used. This is one advantage of the resistive feedback amplifier.

An HP8510 network analyzer in conjunction with the cascade probe station was used to measure the characteristics of this wideband amplifier. The measured and simulated results are shown in Fig. 5(a)–(f) for $|S_{22}|$, $|S_{11}|$, $|S_{21}|$, $|S_{12}|$, $|Z_{21}|$.
(open load transimpedance), $|Z_{TF}|$ (50-Ω load transimpedance), respectively. The measured $S_{21}$ exhibited a flat response with a 3-dB bandwidth of 11.6 GHz, and in-band return loss $|S_{11}|$ and $|S_{22}|$ were less than −10 dB. Note that at higher frequencies (>10 GHz), the simulated $S_{21}$ with TLM agreed better with the measured $S_{21}$ as compared with the simulated $S_{21}$ without TLM. This indicates that the transmission-line effect cannot be ignored when the frequency is higher than 10 GHz. The predicted $S_{21}$ at low frequency by the method we proposed is 17.7 dB, in good agreement with the simulated $S_{21}$ of 17 dB and the measured $|S_{21}|$ of 16 dB. The simulated $S_{11}$ and $S_{22}$ also agreed well with the measured values as shown in Fig. 6(b) and (c), respectively. Also shown are the calculated values of frequency responses from our pole and zero theory for $S_{21}$, $S_{11}$, $S_{22}$, $S_{21}$, $Z_{TF}$, and $Z_{TF}$. Reasonably good agreement with the experimental results is found. The predicted bandwidth is 11.4 GHz, which is comparable to the simulated result with TLM of 11.4 GHz and the measured result of 11.6 GHz. The calculated values of $R_{in}$ and $R_{out}$ by our theory are 37.8 and 49.2 Ω, respectively, which are in good agreement...
with the simulation results of 37.8 and 57 Ω at low frequency. Also shown in Fig. 5(e) and (f) are the transimpedances calculated with an assumed photodetector capacitive load (100 fF) and wire-bond interconnect inductance (1 nH) [15]. Clearly, this degrades the effective transimpedance, and therefore its influence must be considered carefully in the circuit design. The group delay response with all these feedback loops is shown in Fig. 6 and is compared to that without peaking capacitors. As can be seen, the peaking technique has a detrimental effect on group delay.

IV. CONCLUSION

The methodology for the analysis and design of a matched-impedance wideband amplifier with multiple feedback loops was proposed. Expressions for voltage gain, current gain, loop gain, transimpedance gain, bandwidth, input/output resistance, and design equations were derived. A general method for the determination of the frequency responses of input/output return losses from the poles of voltage gain was also presented. The first InGaP–GaAs HBT wide-band amplifier with the Kukielka configuration was designed by the proposed methodology. The experimental results showed that the proposed signal gain of 16 dB and a 3-dB bandwidth of 11.6 GHz with in-band input/output return losses less than 10 dB were obtained. The calculated values of small signal gain, bandwidth, input/output resistance, and frequency responses agreed well with those from experimental results. Thus, the verification of our proposed equations was demonstrated.

REFERENCES


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